TECHNICAL DATA SHEET



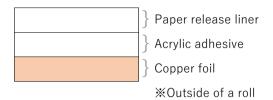
web page



Copper foil adhesive tape

DAITAC® E-1100LC

Construction



Characteristics

- √ 50% thinner compared to E-2100LC
- ✓ Excellent electrical conductivity in thickness direction.
- ✓ Excellent adhesion
- ✓ Product does not use the 6 restrictive substances of the RoHS Directive.

Applications

✓ For EMI shielding of electronic equipment.

Properties

Test item	Condition	Substrate	Unit	E-1100LC
Thickness	Except release liner	-	μm	40
180 deg. peel strength	23°C, 1hr	SUS (hairline)	N/25mm	16.7
		ABS	N/25mm	16.7
		PET	N/25mm	16.7
		PC	N/25mm	16.7
Static shear	70°C, 0.5kg	SUS (hairline)	mm/hr	< 2

Size

1,000mm in max width

50m in length